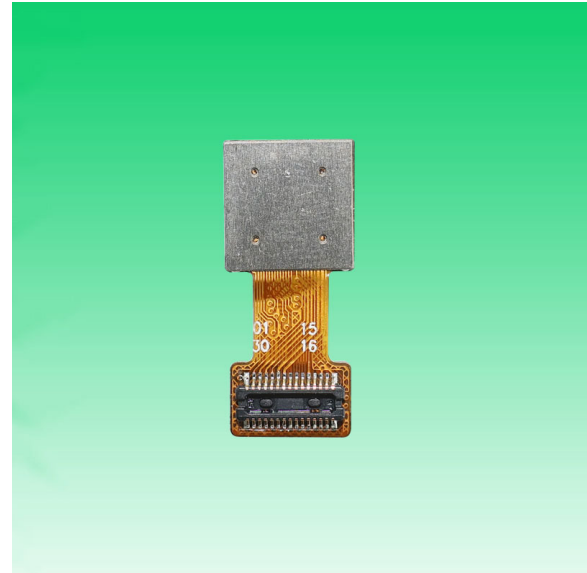


**KLT-MAA57-AR1335 V1.0****13MP OnSemi AR1335 MIPI Interface Auto Focus Camera Module**

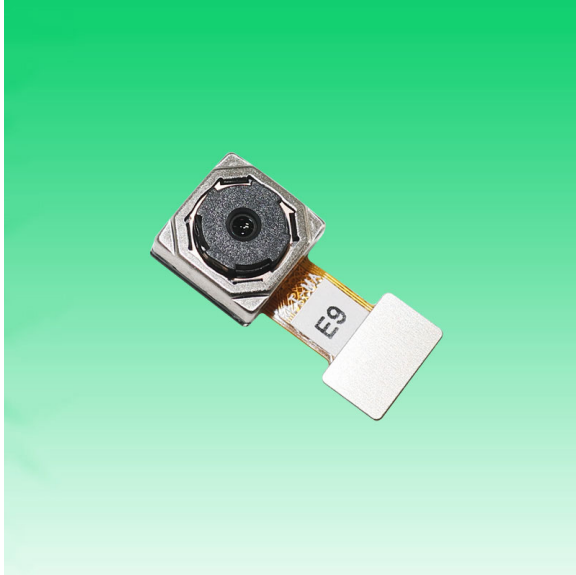
Front View



Back View

**Specifications**

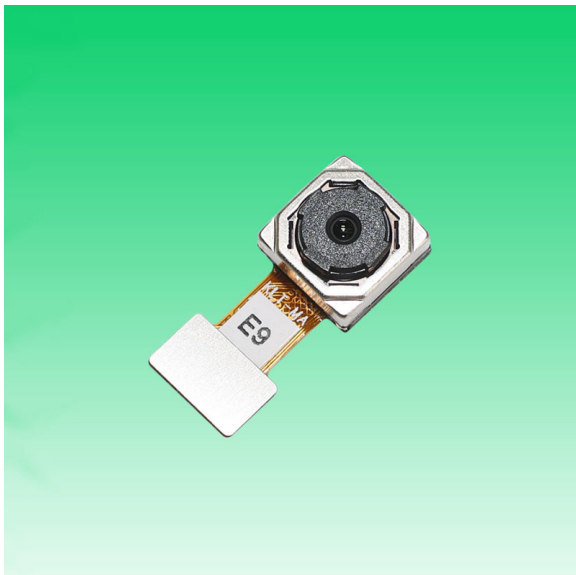
<b>Camera Module No.</b>	<b>KLT-MAA57-AR1335 V1.0</b>
<b>Resolution</b>	13MP
<b>Image Sensor</b>	AR1335
<b>Sensor Type</b>	1/3.2"
<b>Pixel Size</b>	1.1 um x 1.1 um
<b>EFL</b>	2.80 mm
<b>F.NO</b>	1.90
<b>Pixel</b>	4208 x 3120
<b>View Angle</b>	90.3°(DFOV) 77.4°(HFOV) 62.0°(VFOV)
<b>Lens Dimensions</b>	8.50 x 8.50 x 5.35 mm
<b>Module Size</b>	19.57 x 8.50 mm
<b>Module Type</b>	Auto Focus
<b>Interface</b>	MIPI
<b>Auto Focus VCM Driver IC</b>	FP5510
<b>Lens Type</b>	650nm IR Cut
<b>Operating Temperature</b>	-30°C to +70°C
<b>Mating Connector</b>	DF30FC-30DS-0.4V

**KLT-MAA57-AR1335 V1.0****13MP OnSemi AR1335 MIPI Interface Auto Focus Camera Module**

Top View



Side View



Bottom View



Mating Connector







**Periodic table of Elements**

GROUP 1 2 ... 18

1 H 1.008 Hydrogen

3 Li 6.941 Lithium

4 Be 9.01 Beryllium

11 Na 22.99 Sodium

12 Mg 24.31 Magnesium

19 K 39.09 Potassium

20 Ca 40.08 Calcium

37 Rb 85.47 Rubidium

38 Sr 87.62 Strontium

55 Cs 132.9 Cesium

56 Ba 137.3 Barium

87 Fr 223 Francium

88 Ra 226 Radium

89-103 Ac Actinides

21 Sc 44.95 Scandium

22 Ti 47.87 Titanium

39 Y 88.91 Yttrium

40 Zr 91.22 Zirconium

57-71 La Lanthanides

72 Hf 178.5 Hafnium

73 Ta 180.9 Tantalum

74 W 183.8 Tungsten

75 Re 186.2 Rhenium

76 Os 190.2 Osmium

77 Ir 192.22 Iridium

78 Pt 195.08 Platinum

79 Au 196.967 Gold

80 Hg 200.59 Mercury

81 Tl 204.38 Thallium

82 Pb 207.2 Lead

83 Bi 208.98 Bismuth

84 Po (209) Polonium

85 At (210) Astatine

86 Rn (222) Radon

104 Rf 101.07 Rutherfordium

105 Db 102.90 Dubnium

106 Sg 106.10 Seaborgium

107 Bh 107.21 Bohrium

108 Hs 108.90 Hassium

109 Mt 108.90 Meitnerium

110 Ds 110.90 Darmstadtium

111 Rg 111.90 Roentgenium

112 Cn 112.90 Copernicium

113 Nh 113.90 Nihonium

114 Fl 114.90 Flerovium

115 Mc 115.90 Moscovium

116 Lv 116.90 Livermorium

117 Ts 117.90 Tennessine

118 Og 118.90 Oganesson

13 B 10.81 Boron

14 C 12.01 Carbon

15 N 14.01 Nitrogen

16 O 15.99 Oxygen

17 F 18.99 Fluorine

18 Ne 20.18 Neon

13 Al 26.98 Aluminum

14 Si 28.08 Silicon

15 P 30.97 Phosphorus

16 S 32.07 Sulfur

17 Cl 35.45 Chlorine

18 Ar 39.95 Argon

31 Ga 69.72 Gallium

32 Ge 72.61 Germanium

33 As 74.92 Arsenic

34 Se 78.96 Selenium

35 Br 79.90 Bromine

36 Kr 83.80 Krypton

49 In 114.8 Indium

50 Sn 118.7 Tin

51 Sb 121.8 Antimony

52 Te 127.6 Tellurium

53 I 126.9 Iodine

54 Xe 131.3 Xenon

61 Eu 151.96 Europium

62 Gd 157.25 Gadolinium

63 Tb 158.93 Terbium

64 Dy 162.50 Dysprosium

65 Ho 164.93 Holmium

66 Er 167.26 Erbium

67 Tm 168.93 Thulium

68 Yb 173.05 Ytterbium

69 Lu 174.97 Lutetium

89 Ac Actinium

90 Th 232.04 Thorium

91 Pa Protactinium

92 U 238.03 Uranium

93 Np Neptunium

94 Pu 244.06 Plutonium

95 Am Americium

96 Cm Curium

97 Bk Berkelium

98 Cf Californium

99 Es Einsteinium

100 Fm Fermium

101 Md Mendelevium

102 No Nobelium

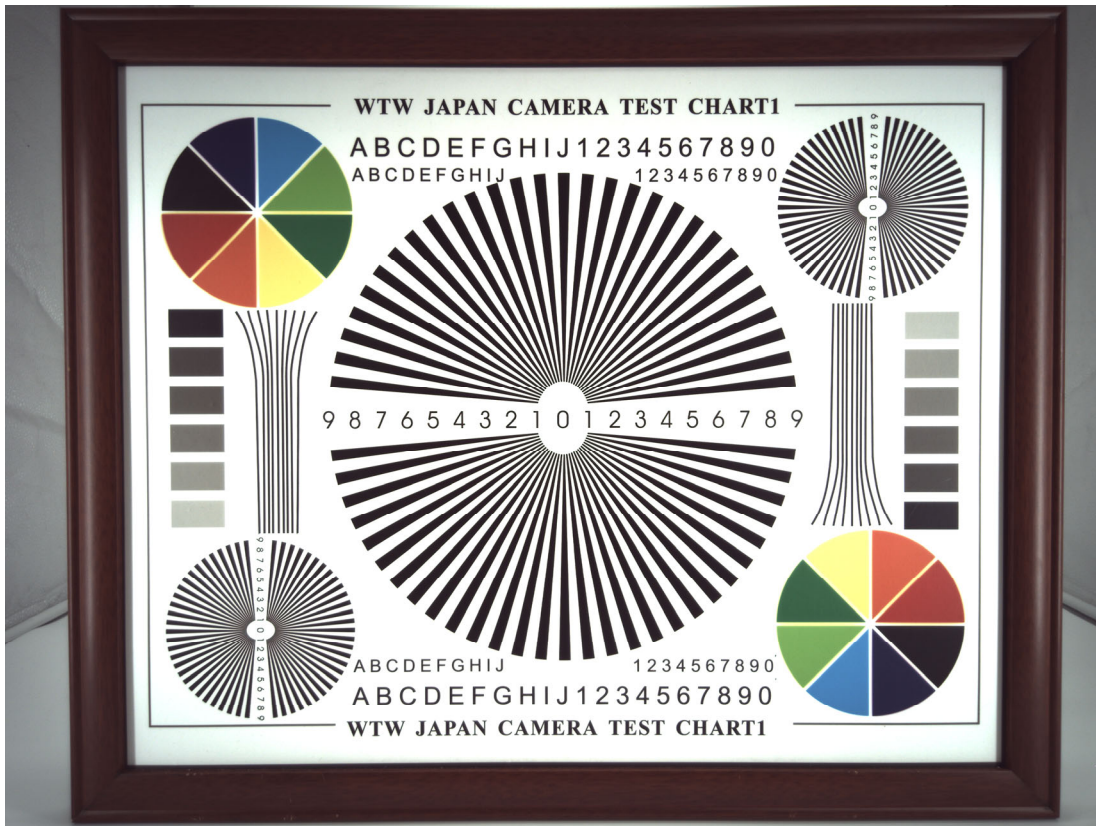
103 Lr Lawrencium

Average Atomic Mass 6.941

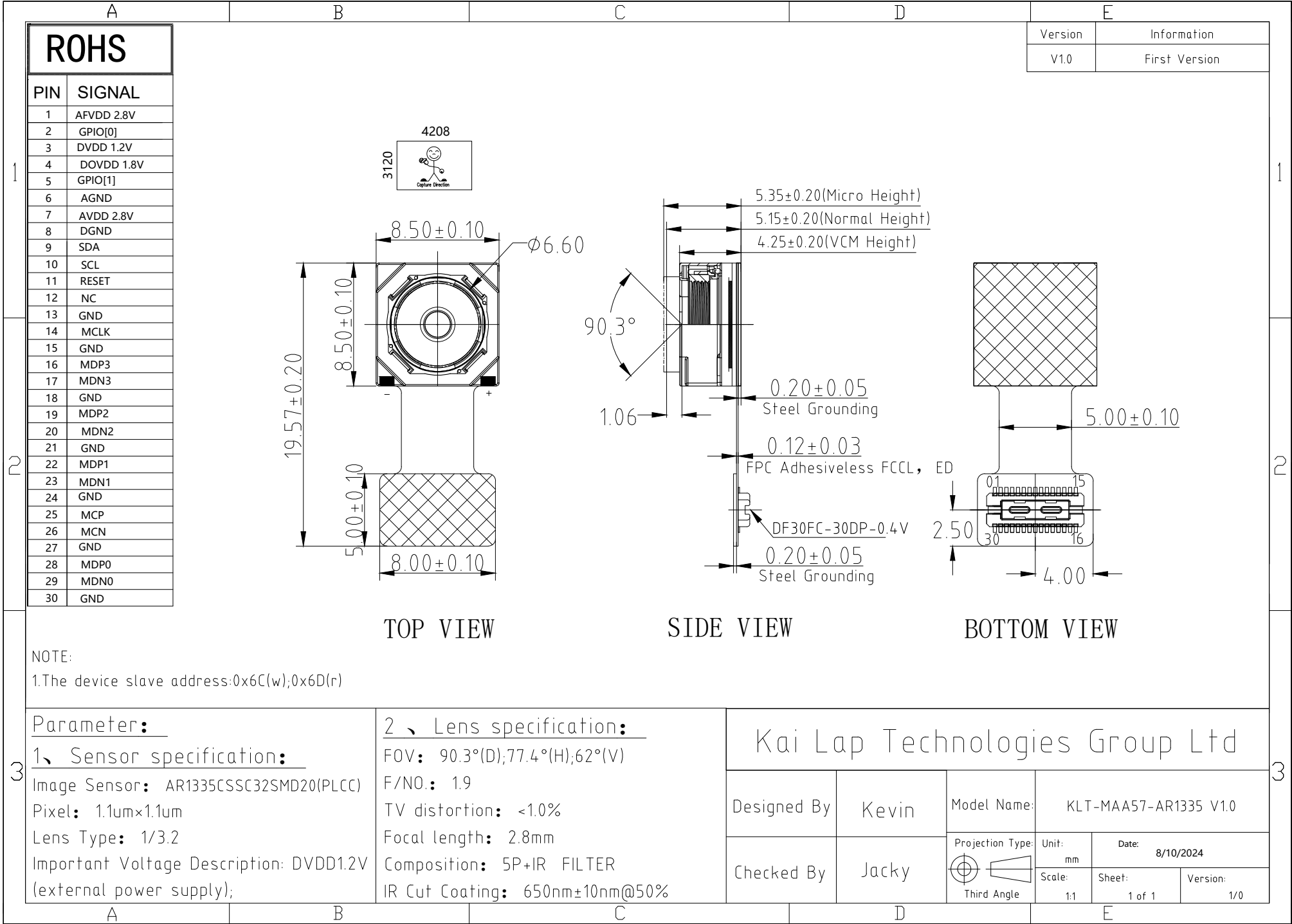
Atomic Number 11

Name Lithium

Symbol Li







## Product Overview

### AR1335: 13 MP 1/3" CMOS Image Sensor

For complete documentation, see the data sheet.



The AR1335 is a 1/3.2-inch CMOS active-pixel digital image sensor with a pixel array of 4208H x 3120V. The AR1335 digital image sensor, features breakthrough 1.1  $\mu\text{m}$  pixel technology that delivers superior low-light image quality through leading sensitivity, quantum efficiency and linear full well. This allows image quality that rivals digital still cameras. With a sensor architecture focused on low power and a high Chief Ray Angle (CRA) for low Z-heights, the AR1335 is ideal for smartphone and other mobile device applications. It incorporates sophisticated on-chip camera functions such as windowing, mirroring, column and row skip modes, and snapshot mode. It is programmable through a simple two-wire serial interface. The AR1335 sensor can generate full resolution image at up to 30 frames per second (fps) and supports advanced video modes including 4K 30fps, 1080P 60fps and 720P 120fps.

## Features

- 13MP CMOS sensor with advanced 1.1  $\mu\text{m}$  pixel BSI technology
  - Data interfaces: 2,3 and 4 lane MIPI
  - Bit-depth compression available for MIPI: 10-8 and 10-6 to lower bandwidth
  - 3D synchronization controls to enable stereo video capture
  - 6.8 kbits one time programmable memory (OTPM)
  - Programmable controls: gain, horizontal and vertical blanking, auto black level offset correction, frame size/rate, exposure, left-right and top-bottom image reversal, window size, and panning
  - Two on-die phase-locked loop (PLL) oscillators for super low noise performance
  - On-chip temperature sensor
  - Bayer pattern horizontal down-size scaler
  - Simple two-wire fast-mode+ serial interface
- For more features, see the data sheet

## Applications

- Mobile
- 4K video capture
- High resolution still capture

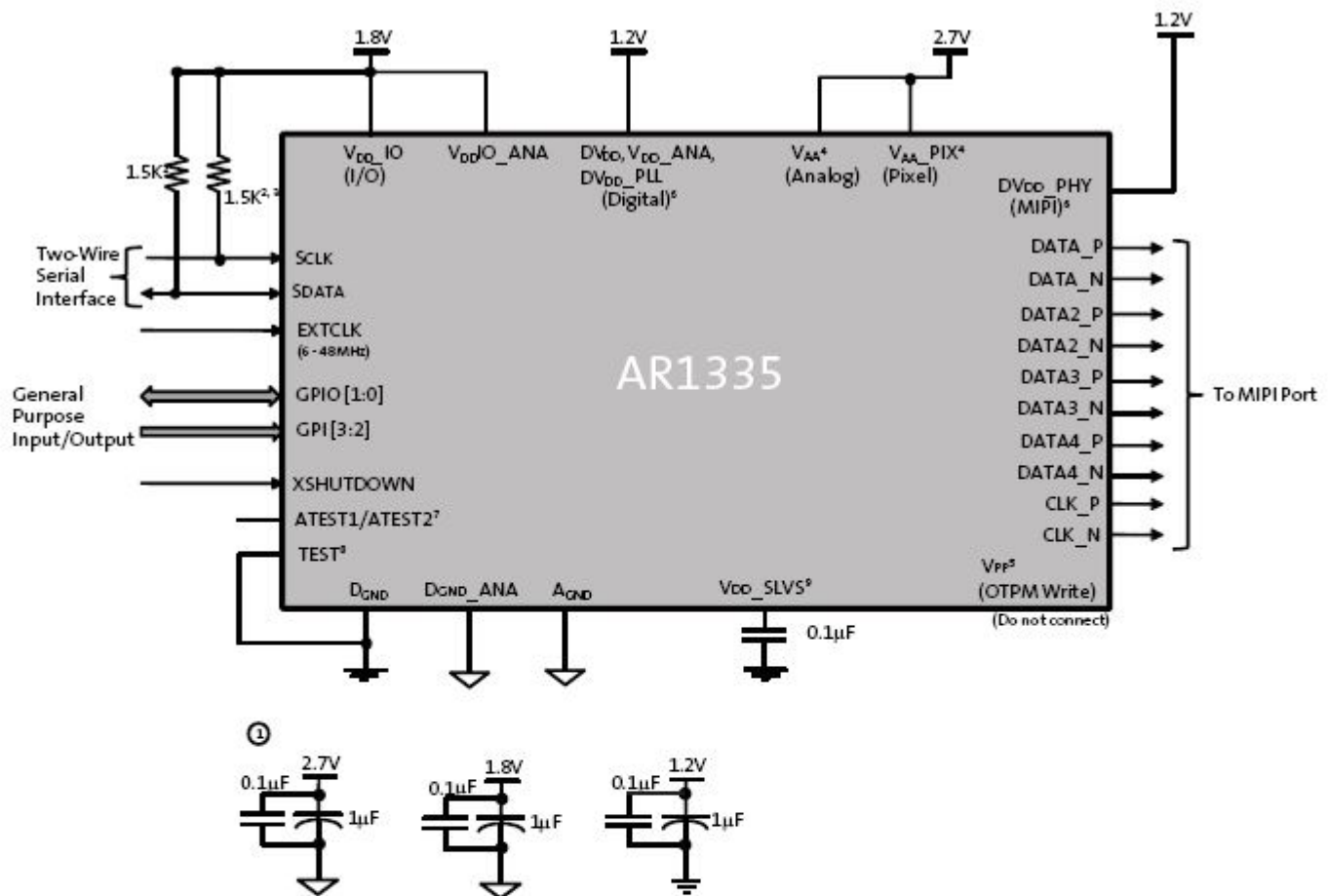
## End Products

- Smart Phone
- Digital Still Camera
- PC Camera
- Consumer devices

## Part Electrical Specifications

Product	Compliance	Status	Type	Megapixels	Frame Rate (fps)	Optical Format	Shutter Type	Pixel Size ( $\mu\text{m}$ )	Output Interface	Color	Package Type
AR1335CSSC11SMD20	Pb-free Halide free	Active	CMOS	13	30	1/3.2 inch	Electronic Rolling	1.1 x 1.1	MIPI	RGB	
AR1335CSSC11SMKA0-CP	Pb-free Halide free	Active	CMOS	13	30	1/3.2 inch	Electronic Rolling	1.1 x 1.1	MIPI	RGB	ODCSP-63
AR1335CSSC11SMKA0-CR	Pb-free Halide free	Active	CMOS	13	30	1/3.2 inch	Electronic Rolling	1.1 x 1.1	MIPI	RGB	ODCSP-63
AR1335CSSC32SMD20	Pb-free Halide free	Active	CMOS	13	30	1/3.2 inch	Electronic Rolling	1.1 x 1.1	MIPI	RGB	
AR1335CSSM11SMD20	Pb-free Halide free	Active	CMOS	13	30	1/3.2 inch	Electronic Rolling	1.1 x 1.1	MIPI	RGB	
AR1335CSSM32SMD20	Pb-free Halide free	Active	CMOS	13	30	1/3.2 inch	Electronic Rolling	1.1 x 1.1	MIPI	RGB	

## Application Diagram



For connectivity above:

Notes:

1. All power supplies should be adequately decoupled; recommended cap values are:
  - 2.7V: 1.0 $\mu$ F and 0.1 $\mu$ F
  - 1.2V: 1.0 $\mu$ F and 0.1 $\mu$ F
  - 1.8V: 1.0 $\mu$ F and 0.1 $\mu$ F
2. Resistor value 1.5k $\Omega$  is recommended, but may be greater for slower two-wire speed.
3. This pull-up resistor is not required if the controller drives a valid logic level on SCLK at all times.
4. VAA and VAA\_PIX must be tied together.
5. Internal charge pump is used for OTPM programming.
6. Digital and MIPI supply can be tied together.
7. ATEST1/ATEST2 must be left floating.
8. TEST pin must be tied to DGND.
9. VDD\_SLVS must be connected to DGND through a bypass cap (0.1 $\mu$ F).

For more information please contact your local sales support at [www.onsemi.com](http://www.onsemi.com).

**Created on: 9/30/2017**





# 1/3.2-Inch 13 Mp CMOS Digital Image Sensor

## AR1335 Datasheet, Rev. A

For the latest datasheet, please visit: [www.aptna.com](http://www.aptna.com)

### Features

- 13 Mp CMOS sensor with advanced 1.1  $\mu\text{m}$  pixel BSI technology
- Data interfaces: two-, three-, and four-lane serial mobile industry processor interface (MIPI)
- Bit-depth compression available for MIPI Interface: 10-8 and 10-6 to enable lower bandwidth receivers for full frame rate applications
- 3D synchronization controls to enable stereo video capture
- 6.8 kbits one-time programmable memory (OTPM) for storing shading correction coefficients and module information
- Programmable controls: gain, horizontal and vertical blanking, auto black level offset correction, frame size/rate, exposure, left-right and top-bottom image reversal, window size, and panning
- Two on-die phase-locked loop (PLL) oscillators for super low noise performance
- On-chip temperature sensor
- Bayer pattern horizontal down-size scaler
- Simple two-wire fast-mode+ serial interface
- Low dark current
- Interlaced multi-exposure readout enabling High Dynamic Range (HDR) still and video applications
- On-chip lens shading correction
- Support for external mechanical shutter
- Support for external LED or Xenon Flash
- Extended Flash duration up to start of frame readout

### Applications

- Cellular phones
- Digital still cameras
- PC cameras
- PDAs

**Table 1: Key Performance Parameters**

Parameter		Value
Optical format		1/3.2 -inch 13 Mp (4:3)
Active pixels		4208H x 3120V
Pixel size		1.1 $\mu\text{m}$ Back Side Illuminated (BSI)
Chief ray angle (CRA)		32°
Die size		6.3 mm x 5.7 mm
Input clock frequency		6 - 48 MHz
Interface		4-lane MIPI (2- and 3-lane supported); Max data rate: 1.2Gbps/lane
Subsampling modes (column and row)		skip2 bin2 skip3 bin3 skip4 bin4 skip2bin2
ADC resolution		10 bits, on-die
Analog gain		1x – 7.75x
Digital gain		Up to 7.98x
Scaler		Adjustable scaling up to 8x
Temperature sensor		10-bit, controlled by two-wire serial I/F
Compression		DPCM: 10-8-10, 10-6-10
3D support		Frame rate and exposure synchronization
Supply voltage	VAA, VAA_PIX	2.6 - 2.9 V (2.7 V nominal)
	VDD_IO, VDDIO_ANA	1.7 - 1.9 V (1.8 V nominal)
	VDD, VDD_ANA, VDD_PLL, VDD_PHY	1.14 - 1.3 V (1.2 V nominal)
Power consumption		270 mW at 60°C (TYP) at 13 Mp 30 fps
Responsivity		4700 e <sup>-</sup> /lux-sec
SNRMAX		37 dB
Dynamic Range		69 dB
Operating Temperature Range (at junction) - TJ		-30°C to +70°C

**Table 2: Mode of Operation and Power**

Mode	Resolution	Readout Configuration	HFOV	FPS	Power Consumption [mW]
<b>4:3 Snapshot Mode</b>					
13 M full resolution	4208x3120	13M full mode	100%	30	270
13 M full resolution	4208x3120	13M full mode	100%	24	250
VGA	640 x 480	Crop+Subsampling+Scaling	61%	120	190
QVGA	320 x 240	Crop+Subsampling+Scaling	30%	240	165
<b>16:9 Video Mode 30 FPS</b>					
4K UHD	3840 x 2160	Cropping	91%	30	230
4K Cinema	4096 x 2160	Cropping	97%	30	235
1080p	1920 x 1080	Crop+Subsampling+Scaling	91%	30	160
1080p LP	1920 x 1080	Crop+Subsampling+Scaling	91%	30	135
720p	1280 x 720	Crop+Subsampling+Scaling	91%	30	140
<b>16:9 Video Mode 60 FPS</b>					
1080p	1920 x 1080	Crop+Subsampling+Scaling	91%	60	210
1080p LP	1920 x 1080	Crop+Subsampling+Scaling	91%	60	180
720p	1280 x 720	Crop+Subsampling+Scaling	91%	60	175
<b>3M 30 FPS</b>					
3M	2000 x 1500	Crop+Subsampling+Scaling	95%	30	195
3M LP	2000 x 1500	Crop+Subsampling+Scaling	95%	30	170
<b>16:9 Video Mode 120 FPS</b>					
720p	1280 x 720	Crop+Subsampling+Scaling	91%	120	260

## Ordering Information

**Table 3: Available Part Numbers**

Part Number	Description
AR1335CSSC32SMD20	Bare die

## 10-Bit DAC 120mA VCM Driver with I<sup>2</sup>C Interface

### Description

The FP5510 is a single 10-bit DAC with 120mA output current voice coil motor (VCM) driver, with an I<sup>2</sup>C-compatible serial interface that operates at clock rates up to 400kHz. Its supply operates from 2.3V to 3.6V.

The FP5510 incorporates with a power-on reset circuit, power-down function. Power-on reset circuit ensure when supply power up, DAC output is to 0V until valid write bit value takes place. In power down mode, the supply current is about 1μA.

The FP5510 is designed for auto focus operation includes digital camera module, optical zoom camera phones and lens auto focus. The I<sup>2</sup>C address of FP5510 is 0x18h.

The FP5510 with WLCSP package which it is suitable for reduced-space mounting in mobile phone and other portable applications.

### Features

- Power Supply Voltage Rang: 2.3V to 3.6V
- VCM Driver for Auto-Focus
- 10-Bit Resolution Current Sinking of 120mA for VCM
- 2-Wire I<sup>2</sup>C Interface (1.8V Interface Compatible)
- Internal 4 Slope Control Mechanism
  1. Enhance Slope Control Mode
  2. One Step Mode
  3. Linear Slope Mode
  4. Two Step Slope Mode
- Power-Save Mode Current < 1μA
- Power On Reset (POR)
- Small Size: 0.7mm×1.1mm (6-Balls WLCSP)

### Applications

- Digital Camera Module
- Cell Phone
- Lens Cover
- Web Camera

### Pin Assignments

#### 6-Ball WLCSP

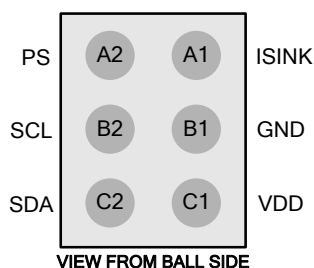



Figure 1. Pin Assignment of FP5510

### Ordering Information

FP5510  Package Type  
E2: WLCSP (6-Ball)

#### WLCSP-6 (0.7mm×1.1mm) Marking

Part Number	Product Code
FP5510E2	2

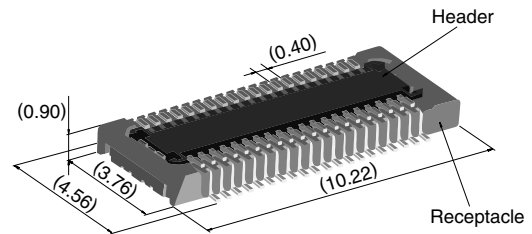


# 0.4 mm Pitch, 0.9 mm Height, Board-to-Board / Board-to-FPC Connectors

## DF30 Series



### Extremely small size



40 positions shown

### Overview

Continuous miniaturization and increased component density on PCB created demand for extremely low profile connectors. This series is addition of a new extremely low profile connectors to Hirose's wide range of high reliability board-to-board/board-to-FPC connection solutions.

### Features

#### 1. Contact reliability

Concentration of the contact's normal forces at the single point assures good contact wipe and electrical reliability, while confirming the fully mated condition with a definite tactile click.

#### 2. Self alignment

Recognizing the difficulties of mating extremely small connectors in limited spaces the connectors will self align in horizontal axis within 0.3 mm.

#### 3. Automatic board placement

Packaged on tape-and-reel the plug and headers have sufficiently large flat areas to allow pick-up with vacuum nozzles of automatic placement equipment.

#### 4. Variety of contact positions and styles

Available in standard contact positions of: 20, 22, 24, 30, 34, 40, 50, 60, 70 and 80 with and without metal fittings. Addition of metal fittings does not affect external dimensions of the connectors.

Smaller contact positions are also available.

#### 5. Support for continuity test connector

Connectors which have increased insertion and removal durability are available for continuity tests. Contact your Hirose sales representative for details.

### Applications

Cellular phones, PDA's, mobile computers, digital cameras, digital video cameras, and other devices demanding high reliability connections in extremely limited spaces.

### Low profile

### Increased mated retention

### High contact reliability



### Self alignment



## ■Product Specifications

Rating	Rated current 0.3A Rated voltage 30V AC	Operating temperature range : -35℃ to 85℃ (Note 1) Operating humidity range : Relative humidity 20% to 80%	Storage temperature range -10℃ to 60℃ (Note 2) Storage humidity range Relative humidity 40% to 70% (Note 2)
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Item	Specification	Conditions
1. Insulation resistance	50 MΩ min.	100V DC
2. Withstanding voltage	No flashover or insulation breakdown.	100V AC / one minute
3. Contact resistance	100 mΩ max.	100 mA
4. Vibration	No electrical discontinuity of 1 μs or more	Frequency: 10 to 55 Hz, single amplitude of 0.75mm, 2 hours, 3 axis
5. Humidity	Contact resistance: 100 mΩ max. Insulation resistance: 25 MΩ min.	96 hours at temperature of 40℃±2℃ and RH of 90% to 95%
6. Temperature cycle	Contact resistance: 100 mΩ max. Insulation resistance: 50 MΩ min.	Temperature: -55℃→+5℃ to +35℃→+85℃→+5℃ to +35℃ Duration: 30→10→30→10(Minutes) 5 cycles
7. Durability (insertions/withdrawals)	Contact resistance: 100 mΩ max.	50 cycles(Connector for conductivity tests: 500 cycles)
8. Resistance to soldering heat	No deformation of components affecting performance.	Reflow: At the recommended temperature profile Manual soldering: 300℃ for 3 seconds

Note 1: Includes temperature rise caused by current flow.

Note 2: The term "storage" refers to products stored for long period of time prior to mounting and use. Operating temperature range and humidity range covers non-conducting condition of installed connectors in storage, shipment or during transportation.

## ■Materials and Finishes

Connectors	Component	Material	Finish	Remarks
Receptacles and Headers	Insulator	LCP	Color : Black	UL94V-0
	Contacts	Phosphor bronze	Gold plated	————
	Metal fittings	Phosphor bronze	Tin-copper plated	————

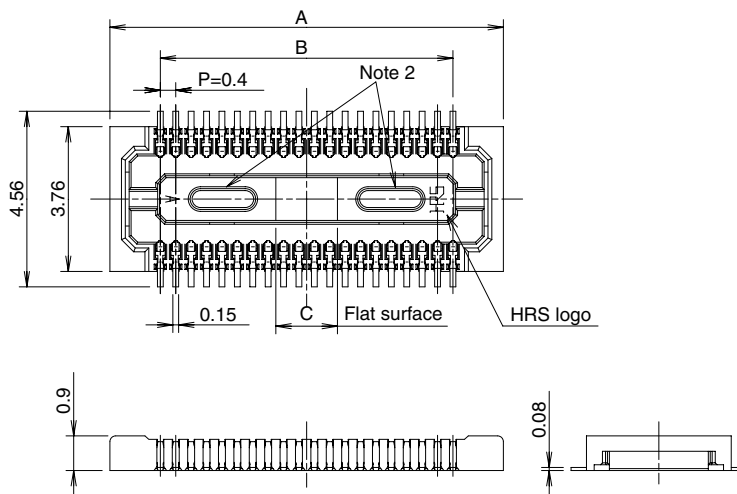
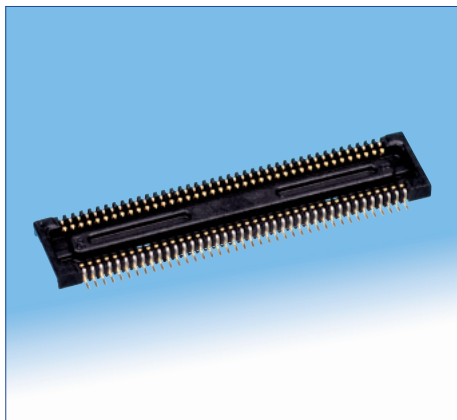
## ■Ordering information

### ●Receptacles and Headers

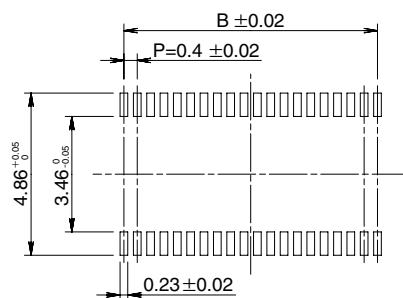
**DF30**   **FC** -   **\***   **DS - 0.4**   **V**   **(\*\*)**

① Series name: DF30	⑤ Contact pitch: 0.4 mm
② Configuration FB: With metal fittings, without bosses FC: Without metal fittings, without bosses CJ: Connector for conductivity tests	⑥ Termination section V: Straight SMT
③ Number of positions: 20, 22, 24, 30, 34, 40, 50, 60, 70, 80	⑦ Packaging (81): Embossed tape packaging (5,000 pieces per reel) (82): Embossed tape packaging (1,000 pieces per reel)
④ Connector type DS: Double row receptacle DP: Double row header	

## ■Receptacles (without metal fittings)



## ◆Recommended PCB mounting pattern



Recommended solder paste thickness: 120  $\mu$ m

[Specification number] -\*\*, (\*\*)

(81): Embossed tape packaging (5,000 pieces per reel)

\* Tolerances non- accumulative.

Unit: mm

Part Number	CL No.	Number of contacts	A	B	C
DF30FC-20DS-0.4V(**)	CL684-1109-8-**-	20	6.22	3.6	1.2
DF30FC-22DS-0.4V(**)	CL684-1110-7-**-	22	6.62	4.0	1.2
DF30FC-24DS-0.4V(**)	CL684-1111-0-**-	24	7.02	4.4	1.2
DF30FC-30DS-0.4V(**)	CL684-1112-2-**-	30	8.22	5.6	1.2
DF30FC-34DS-0.4V(**)	CL684-1113-5-**-	34	9.02	6.4	1.36
DF30FC-40DS-0.4V(**)	CL684-1078-6-**-	40	10.22	7.6	1.6
DF30FC-50DS-0.4V(**)	CL684-1114-8-**-	50	12.22	9.6	2.0
DF30FC-60DS-0.4V(**)	CL684-1082-3-**-	60	14.22	11.6	2.4
DF30FC-70DS-0.4V(**)	CL684-1115-0-**-	70	16.22	13.6	2.8
DF30FC-80DS-0.4V(**)	CL684-1116-3-**-	80	18.22	15.6	3.2

Note 1: Order by number of reels.

Note 2: Receptacles with 24 or fewer contacts positions will not have recessed areas.



## Cameras Applications



Automotive Driver Pilot



Live Streaming



Video Conference



Eye Tracker Biometric Detection



Machine Vision



Agricultural Monitor



Night Vision Security



Drone and Sports Eagle Eyes



Interactive Pet Camera



## Cameras Applications

*your BEST camera module partner*



### IMAGING DEVICES



## Camera Module Pinout Definition Reference Chart

OmniVision Sony Samsung On-Semi Aptina Himax GalaxyCore PixArt SmartSens Sensors	
Pin Signal	Description
DGND GND	ground for digital circuit
AGND	ground for analog circuit
PCLK DCK	DVP PCLK output
XCLR PWDN XSHUTDOWN STANDBY	power down active high with internal pull-down resistor
MCLK XVCLK XCLK INCK	system input clock
RESET RST	reset active low with internal pull-up resistor
NC NULL	no connect
SDA SIO_D SIOD	SCCB data
SCL SIO_C SIOC	SCCB input clock
VSYNC XVS FSYNC	DVP VSYNC output
HREF XHS	DVP HREF output
DOVDD	power for I/O circuit
AFVDD	power for VCM circuit
AVDD	power for analog circuit
DVDD	power for digital circuit
STROBE FSTROBE	strobe output
FSIN	synchronize the VSYNC signal from the other sensor
SID	SCCB last bit ID input
ILPWM	mechanical shutter output indicator
FREX	frame exposure / mechanical shutter
GPIO	general purpose inputs
SLASEL	I2C slave address select
AFEN	CEN chip enable active high on VCM driver IC
<b>MIPI Interface</b>	
MDN0 DN0 MD0N DATA_N DMO1N	MIPI 1st data lane negative output
MDP0 DP0 MD0P DATA_P DMO1P	MIPI 1st data lane positive output
MDN1 DN1 MD1N DATA2_N DMO2N	MIPI 2nd data lane negative output
MDP1 DP1 MD1P DATA2_P DMO2P	MIPI 2nd data lane positive output
MDN2 DN2 MD2N DATA3_N DMO3N	MIPI 3rd data lane negative output
MDP2 DP2 MD2P DATA3_P DMO3P	MIPI 3rd data lane positive output
MDN3 DN3 MD3N DATA4_N DMO4N	MIPI 4th data lane negative output
MDP3 DP3 MD3P DATA4_P DMO4P	MIPI 4th data lane positive output
MCN CLKN CLK_N DCKN	MIPI clock negative output
MCP CLKP MCP CLK_P DCKN	MIPI clock positive output
<b>DVP Parallel Interface</b>	
D0 DO0 Y0	DVP data output port 0
D1 DO1 Y1	DVP data output port 1
D2 DO2 Y2	DVP data output port 2
D3 DO3 Y3	DVP data output port 3
D4 DO4 Y4	DVP data output port 4
D5 DO5 Y5	DVP data output port 5
D6 DO6 Y6	DVP data output port 6
D7 DO7 Y7	DVP data output port 7
D8 DO8 Y8	DVP data output port 8
D9 DO9 Y9	DVP data output port 9
D10 DO10 Y10	DVP data output port 10
D11 DO11 Y11	DVP data output port 11



## Camera Reliability Test

Reliability Inspection Item			Testing Method	Acceptance Criteria
Category		Item		
Environmental	Storage Temperature	High 60°C 96 Hours	Temperature Chamber	No Abnormal Situation
		Low -20°C 96 Hours	Temperature Chamber	No Abnormal Situation
	Operation Temperature	High 60°C 24 Hours	Temperature Chamber	No Abnormal Situation
		Low -20°C 24 Hours	Temperature Chamber	No Abnormal Situation
	Humidity	60°C 80% 24 Hours	Temperature Chamber	No Abnormal Situation
	Thermal Shock	High 60°C 0.5 Hours Low -20°C 0.5 Hours Cycling in 24 Hours	Temperature Chamber	No Abnormal Situation
Physical	Drop Test (Free Falling)	Without Package 60cm	10 Times on Wood Floor	Electrically Functional
		With Package 60cm	10 Times on Wood Floor	Electrically Functional
	Vibration Test	50Hz X-Axis 2mm 30min	Vibration Table	Electrically Functional
		50Hz Y-Axis 2mm 30min	Vibration Table	Electrically Functional
		50Hz Z-Axis 2mm 30min	Vibration Table	Electrically Functional
	Cable Tensile Strength Test	Loading Weight 4 kg 60 Seconds Cycling in 24 Hours	Tensile Testing Machine	Electrically Functional
Electrical	ESD Test	Contact Discharge 2 KV	ESD Testing Machine	Electrically Functional
		Air Discharge 4 KV	ESD Testing Machine	Electrically Functional
	Aging Test	On/Off 30 Seconds Cycling in 24 Hours	Power Switch	Electrically Functional
	USB Connector	On/Off 250 Times	Plug and Unplug	Electrically Functional



Inspection Item		Inspection Method	Standard of Inspection		
Category					
Item					
Appearance	FPC/ PCB	Color	The Naked Eye	Major Difference is Not Allowed.	
		Be Torn/Chopped	The Naked Eye	Copper Crack Exposure is Not Allowed.	
		Marking	The Naked Eye	Clear, Recognizable (Within 30cm Distance)	
	Holder	Scratches	The Naked Eye	The Inside Crack Exposure is Not Allowed	
		Gap	The Naked Eye	Meet the Height Standard	
		Screw	The Naked Eye	Make Sure Screws Are Presented (If Any)	
		Damage	The Naked Eye	The Inside Crack Exposure is Not Allowed	
	Lens	Scratch	The Naked Eye	No Effect On Resolution Standard	
		Contamination	The Naked Eye	No Effect On Resolution Standard	
		Oil Film	The Naked Eye	No Effect On Resolution Standard	
		Cover Tape	The Naked Eye	No Issue On Appearance.	
	Function	Image	No Communication	Test Board	Not Allowed
			Bright Pixel	Black Board	Not Allowed In the Image Center
Dark Pixel			White board	Not Allowed In the Image Center	
Blurry			The Naked Eye	Not Allowed	
No Image			The Naked Eye	Not Allowed	
Vertical Line			The Naked Eye	Not Allowed	
Horizontal Line			The Naked Eye	Not Allowed	
Light Leakage			The Naked Eye	Not Allowed	
Blinking Image			The Naked Eye	Not Allowed	
Bruise			Inspection Jig	Not Allowed	
Resolution			Chart	Follows Outgoing Inspection Chart Standard	
Color			The Naked Eye	No Issue	
Noise			The Naked Eye	Not Allowed	
Corner Dark			The Naked Eye	Less Than 100px By 100px	
Color Resolution			The Naked Eye	No Issue	
Dimension			Height	The Naked Eye	Follows Approval Data Sheet
	Width	The Naked Eye	Follows Approval Data Sheet		
	Length	The Naked Eye	Follows Approval Data Sheet		
	Overall	The Naked Eye	Follows Approval Data Sheet		

## KLT Package Solutions

KLT Camera Module



Complete with Lens Protection Film



Tray with Grid and Space



Place Cameras on the Tray





## Camera Modules Package Solution

Full Tray of Cameras



Cover Tray with Lid



Put Tray into Anti-Static Bag



Vacuum the Anti-Static Bag



## Camera Modules Package Solution

**Sealed Vacuum Bag with Labels**

**1. Model and Description 2. Quantity 3. Shipping Date 4. Caution**





## Large Order Package Solution

Place Foam Sheets Between Trays



Foam Sheets are Slightly Larger than Trays



Place Foam Sheets and Trays into Box



Foam Sheets are Tightly Fitting Box



## Small Order Package Solution

Place Foam Sheets and Trays into Small Box



Foam Sheets are Nicely Fitting the Small Box



Package in Small Box for Shipment



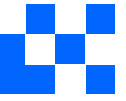
Place Small Boxes into Larger Box







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## Carbon Box Package Solution

Seal the Carbon Box

Final Package Labelled Box



### Carbon Box Ready for Shipment

1. Delivery Address and Phone No. 2. Box No. and Ship Date 3. Fragile Caution



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## Sample Order Package Solution

Place Sample into Small Anti-Static Bag



Place Connectors into Small Ant-Static Bag



### Sample Labels on the Small Bag

1. Camera Module or Connector Model 2. Shipping Date and Quantity 3. Caution





## Connectors Large Order Package Solution

## Connectors in a Wheel



## Label Connectors in the Wheel



## The Wheel is Perfectly Fitting the Box

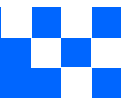


## Connectors Box Ready for Shipment





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## Company Kai Lap Technologies (KLT)

Kai Lap Technologies Group Limited. (KLT) was established in 2009, a next-generation technology driven manufacturer specialized in research, design, and produce of audio and video products. KLT is occupying 20,000 square feet automated plants with 100 employees of annual throughput 30,000,000 units cameras.

KLT provides OEM, ODM design, contract manufacturing, and builds the camera products. You may provide the requirements to us, even with a hand draft, our sales and engineering work together to meet your needs. We consider ourselves your last-term partner in developing practical and innovative solutions.

Our team covers everything from initial concept development to mass produced product. KLT specializes in customized camera design, raw material, electronic engineering, firmware/software development, product testing, and packing design. Our experienced strategic supply systems offer a robust and dependable manufacturing capacity for orders of various sizes.



## Limited Warranty

KLT provides the following limited warranty if you purchased the Product(s) directly from KLT company or from KLT's website, [www.KaiLapTech.com](http://www.KaiLapTech.com). Product(s) purchased from other sellers or sources are not covered by this Limited Warranty. KLT guarantees that the Product(s) will be free from defects in materials and workmanship under normal use for a period of one (1) year from the date you receive the product ("Warranty Period").

For all Product(s) that contain or develop material defects in materials or workmanship during the Warranty Period, KLT will, at its sole option, either: (i) repair the Product(s); (ii) replace the Product(s) with a new or refurbished Product(s) (replacement Product(s) being of identical model or functional equivalent); or (iii) provide you a refund of the price you paid for the Product(s).

This Limited Warranty of KLT is solely limited to repair and/or replacement on the terms set forth above. KLT is not reliable or responsible for any subsequent events.



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## KLT Strength

### Powerful Factory



### Professional Service



### Promised Delivery



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